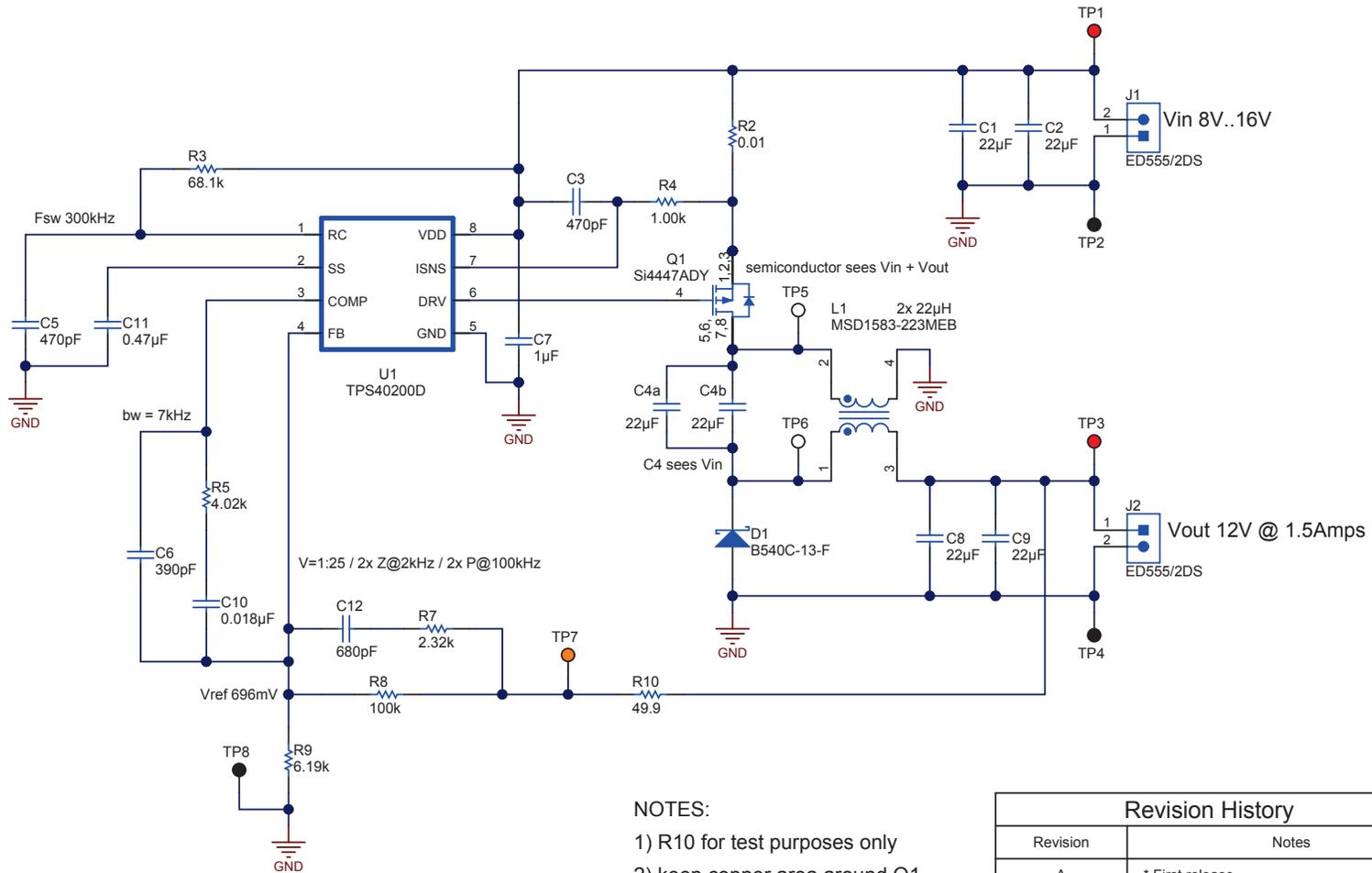


basic ZETA demo for TI Power Workshop:



NOTES:

- 1) R10 for test purposes only
- 2) keep copper area around Q1

Revision History

Revision	Notes
A	* First release
B	* tuned loop

Designed for: Public Release	Mod. Date: 8/22/2014
Project Title: ZETA demo	
Sheet Title:	
Number: PMP10070	Rev: B
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted
Drawn By:	File: PMP10070RevB.SchDoc
Engineer: B.Geck	Contact: http://www.ti.com/support



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Number: PMP10070 | Rev: B
 SVN Rev: Not in version control
 Drawn By:
 Engineer: B.Geck

Mod. Date: 8/22/2014
 Project Title: ZETA demo
 Sheet Title:
 Assembly Variant: Variant name not interpreted | Sheet: 1 of 1
 File: PMP10070RevB.SchDoc | Size: A4
 Contact: <http://www.ti.com/support>

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